

BigTwin SuperServer SYS-222BT-HNR

2U 4-Node BigTwin with 6 hot-swap 2.5" NVMe drives per node



Key Applications

All-Flash NVMe Hyperconverged Infrastructure, Container-as-a-Service; Application Accelerator, High-Performance File System, Diskless HPC Clusters,

Key Features

- Dual Socket E2 Intel® Xeon® 6 6700 series processors with E-cores up to 205W with air cooling or 330W with liquid cooling;
- Up to 16 DIMMs supporting up to 4TB DDR5-6400 in 1DPC;
- Flexible networking with OCP 3.0 AIOM slot;
- Up to 2 PCIe 5.0 x16 LP slots Internal PCIe 5.0 for 2x NVMe M.2 support onboard Optional 4x NVMe M.2 support onboard with built-in HW RAID1 via SCC-A2NM2241GH-B1;
- Up to 6 front hot-swap 2.5" PCIe 5.0 NVMe drive bays;
- Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:;



Form Factor	2U Rackmount
	Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75")
	Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")
Processor	Dual Socket E2 (LGA-4710)
	Intel® Xeon® 6 6700 series processors with E-cores
	Up to 144C/144T; Up to 108MB Cache per CPU
System Memory	Slot Count: 16 DIMM slots
	Max Memory (1DPC): Up to 4TB 6400MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Default: Total 6 bay(s)
	• 6 front hot-swap 2.5" PCIe 5.0 NVMe drive bay(s)
	M.2: 2 M.2 PCIe 5.0 x4 NVMe slot(s) (M-key 22110(default); VROC required for RAID)
Expansion Slots	Default
	• 2 PCIe 5.0 x16 LP slot(s)
	• 1 PCIe 5.0 x16 AIOM slot(s) (OCP 3.0 compatible)
On-Board Devices	Chipset: System on Chip
	Network Connectivity: Via AIOM
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port(s)
	USB: 2 USB 3.0 Gen2 Type-A port(s) (Rear)
	Video: 1 VGA port(s)



Power Button LED

(Node B)

(Node D)

(Node A)

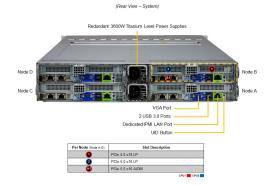
(Node C)

UR Button LEDs

(Node A)

(Node C)

(Front View - System)



System Cooling	Fans: 4x 16K RPM Counter Rotating 80x80x56mm Fan(s) Liquid Cooling: Direct to Chip (D2C) Cold Plate (optional)
Power Supply	2x 3600W Redundant (1 + 1) Titanium Level (96%) power supplies
System BIOS	BIOS Type: AMI 32MB Flash ROM
Management	SuperCloud Composer; Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
PC Health Monitoring	FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment CPU: Monitors for CPU Cores, Chipset Voltages, Memory. 8+4 Phase-switching voltage regulator
Dimensions and Weight	Weight: Gross Weight: 96.6 lbs (43.8 kg) Net Weight: 66.1 lbs (30 kg) Available Color: Black front & silver body
Operating Environment	RoHS Compliant Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -30°C to 60°C (-22°F to 140°F) Operating Relative Humidity: 8% to 80% (non-condensing) Non-operating Relative Humidity: 8% to 90% (non-condensing)
Motherboard	Super X14DBT-B
Chassis	CSE-217BQ2-R3K60P